

## CALL FOR NOMINATIONS – Due February 15, 2012



### **2012 ASME ALLAN KRAUS THERMAL MANAGEMENT MEDAL FOR EXCELLENCE IN THERMAL MANAGEMENT OF ELECTRONIC SYSTEMS**

#### **ACHIEVEMENT RECOGNIZED**

In 2009 the ASME Electronic & Photonic Packaging Division (EPPD) and the ASME Committee on Honors elevated the EPPD Thermal Management Award to a Society Level Award. Henceforth, this award will be known as the ASME Allan Kraus Thermal Management Medal for excellence in thermal management of electronic systems.

The award will be given annually by the Society to an individual who is widely recognized for meritorious contributions to the field of thermal management of electronic systems through research, scholarship, publication, patent(s), teaching, and/or technical leadership in the development and implementation of significant thermal management technology. This award also seeks to recognize individuals who have demonstrated a commitment to the field of thermal management of electronic systems, through outstanding leadership in the development of the profession and/or as mentors to young engineers.

#### **FORM OF AWARD**

Medal, \$1000 honorarium, and a travel expense supplement, in accordance with the Committee on Honors Policy, to attend the meeting of presentation.

#### **NOMINATION**

Nominations are sought for the 2012 Allan Kraus Thermal Management Medal. The deadline for submission of nominations is **February 15, 2012**. Please submit nominations via email to Prof. Avram Bar-Cohen ([abc@umd.edu](mailto:abc@umd.edu)), Chair of the Allan Kraus Thermal Management Medal Committee. The nomination form can be accessed at: <http://files.asme.org/asmeorg/Governance/Honors/SocietyAwards/7758.doc>

The nomination package must include a curriculum vita of the nominee, a statement of qualification, and 4-5 letters of recommendation supporting the nomination. Individuals previously recognized with the EPPD (Division Level) Thermal Management Award are not eligible for consideration.

If a suitable candidate is identified, the Committee will forward the nomination to the COH for its approval with a recommended presentation at the 2012 ASME International Mechanical Engineering Congress and Exposition (IMECE).

#### **CONTACT INFORMATION**

Professor Avram Bar-Cohen ([abc@umd.edu](mailto:abc@umd.edu))